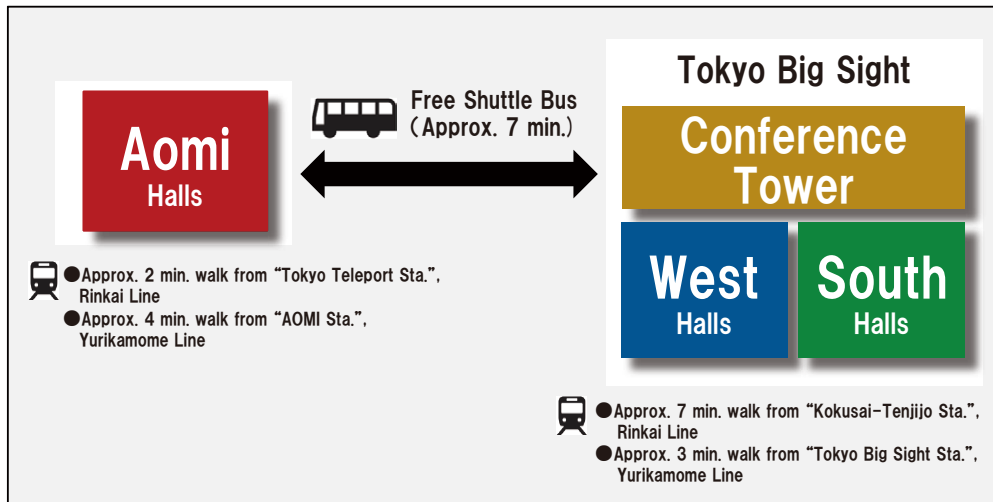


Conference / Forum Venue Overview

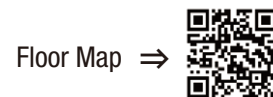
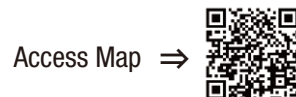
4 different Conference & Forum venues will be located in each building
(Conference Tower, Aomi Halls, West Halls and South Halls)



*"Lightweight Technology Innovation Forum", "Smart Mobility Start-ups Forum", "Israel Pavilion's Pitch Event" will be held inside the exhibition halls.
For your entry to the hall, visitor registration with an invitation ticket is required.
Since visitor registration might take some time, it is recommended that you come to "Visitor Registration Counter" 20 minutes before the start of the session.

*There are some sessions (i.e. Exhibitors' Presentation, etc.) which are not listed here.
Please refer to the floor map for their venue locations.

*Speakers and programs are subject to change.



Keynote Session / Special Session / MaaS Forum / Technical Session

Venue: Conference Tower, Tokyo Big Sight

**Pre-
registration
is required**

Date	Starting Time	Session No.	Conference Room	Session Name
Jan. 15 [Wed]	10:30~	NEPCON-K	608, 6F	NEPCON JAPAN Keynote Session
		AUTO-K	Reception Hall, 1F	AUTOMOTIVE WORLD Keynote Session
		INJ-1	101, 1F	INTERNEPCON JAPAN Technical Session(1)
		ISP-1	102, 1F	IC & SENSOR PACKAGING TECHNOLOGY EXPO Technical Session(1)
		ISP-2	703, 7F	IC & SENSOR PACKAGING TECHNOLOGY EXPO Technical Session(2)
	13:00~	NEPCON-S1	Int'l Conference Room, 7F	NEPCON JAPAN Special Session(1)
		AUTO-S1	Reception Hall, 1F	AUTOMOTIVE WORLD Special Session(1)
	15:30~	NEPCON-S5	608, 6F	NEPCON JAPAN Special Session(5)
		AUTO-M1	Reception Hall, 1F	AUTOMOTIVE WORLD MaaS Forum(1)
		ISP-3	701, 7F	IC & SENSOR PACKAGING TECHNOLOGY EXPO Technical Session(3)
PWB-1		103, 1F	PWB EXPO Technical Session(1)	
PWB-2		703, 7F	PWB EXPO Technical Session(2)	
AUTO-1		102, 1F	AUTOMOTIVE WORLD Technical Session(1)	
AUTO-2		101, 1F	AUTOMOTIVE WORLD Technical Session(2)	

Jan. 16 [Thu]	10:00~	NEPCON-S2	Reception Hall, 1F	NEPCON JAPAN Special Session(2)
		AUTO-S2	Int'l Conference Room, 7F	AUTOMOTIVE WORLD Special Session(2)
		INJ-2	102, 1F	INTERNEPCON JAPAN Technical Session(2)
		PWB-3	703, 7F	PWB EXPO Technical Session(3)
	12:30~	PWB-4	101, 1F	PWB EXPO Technical Session(4)
		AUTO-M2	Int'l Conference Room, 7F	AUTOMOTIVE WORLD MaaSForum(2)
		ISP-4	101, 1F	IC & SENSOR PACKAGING TECHNOLOGY EXPO Technical Session(4)
	15:00~	AUTO-3	703, 7F	AUTOMOTIVE WORLD Technical Session(3)
		AUTO-4	102, 1F	AUTOMOTIVE WORLD Technical Session(4)
		AUTO-S3	Int'l Conference Room, 7F	AUTOMOTIVE WORLD Special Session(3)
AUTO-S4		Reception Hall, 1F	AUTOMOTIVE WORLD Special Session(4)	
ISP-5		101, 1F	IC & SENSOR PACKAGING TECHNOLOGY EXPO Technical Session(5)	
ISP-6		102, 1F	IC & SENSOR PACKAGING TECHNOLOGY EXPO Technical Session(6)	
15:00~	PWB-5	703, 7F	PWB EXPO Technical Session(5)	
	AUTO-5	606, 6F	AUTOMOTIVE WORLD Technical Session(5)	
	AUTO-6	608, 6F	AUTOMOTIVE WORLD Technical Session(6)	

Jan. 17 [Fri]	10:00~	NEPCON-S3	Int'l Conference Room, 7F	NEPCON JAPAN Special Session(3)
		AUTO-M3	Reception Hall, 1F	AUTOMOTIVE WORLD MaaSForum(3)
		INJ-3	703, 7F	INTERNEPCON JAPAN Technical Session(3)
		ISP-7	101, 1F	IC & SENSOR PACKAGING TECHNOLOGY EXPO Technical Session(7)
		AUTO-7	606, 6F	AUTOMOTIVE WORLD Technical Session(7)
	12:30~	AUTO-8	608, 6F	AUTOMOTIVE WORLD Technical Session(8)
		NEPCON-S4	Int'l Conference Room, 7F	NEPCON JAPAN Special Session(4)
		AUTO-S5	Reception Hall, 1F	AUTOMOTIVE WORLD Special Session(5)
	15:00~	ISP-8	608, 6F	IC & SENSOR PACKAGING TECHNOLOGY EXPO Technical Session(8)
		PWB-6	101, 1F	PWB EXPO Technical Session(6)
NEPCON-S6		608, 6F	NEPCON JAPAN Special Session(6)	
AUTO-S6		606, 6F	AUTOMOTIVE WORLD Special Session(6)	
15:00~	AUTO-S7	Int'l Conference Room, 7F	AUTOMOTIVE WORLD Special Session(7)	

See other side for "Lightweight Technology Innovation Forum", "Smart Mobility Start-ups Forum", "Israel Pavilion's Pitch Event".

Seminars held inside exhibition halls.

Lightweight Technology Innovation Forum

Venue: West Hall 3, Tokyo Big Sight

Pre-registration is required

	Jan. 15 [Wed]	Jan. 16 [Thu]	Jan. 17 [Fri]
10:30 } 12:00 ※ALT-7 ~11:30	ALT-1 Ultra High Tensile Steel -- Latest Use Case and Challenges Mazda Motor Corp./ JFE Steel Corp.	ALT-4 Multi-material Body! -- Latest Examples and Future Prospect AluMag./Tohoku University	ALT-7 Latest Cases of Small Vehicle Weight Reduction Mazda Motor Corp.
13:00 } 14:30	ALT-2 Evolution of Dissimilar Materials Joining and Structural Bonding -- Improved Utility and Reliability Mazda Motor Corp./ Daihen Corp.	ALT-5 Search for Next-generation Highly-functional Materials by AI National Institute for Materials Science (NIMS)/ Meiji University	ALT-8 Weight Reduction of EVs -- A Challenge for Range Extension ContiTech China Rubber & Plastics Technology Ltd./ BloombergNEF
15:30 } 17:00	ALT-3 Concepts and Practical Application of CFRP Toyota Motor Corp./ Teijin Ltd.	ALT-6 Magnesium: Weight Reduction with Magnesium and Its Potential Honda R&D Co., Ltd./ The University of Tokyo	◆ ◆ ◆

Smart Mobility Start-ups Forum

Venue: Aomi Hall B ★2

FREE no pre-registration required

	Jan. 15 [Wed]	Jan. 16 [Thur]	Jan. 17 [Fri]
11:00 11:40	Grip-Coefficient Monitoring, GIS by Sensor-fusion Technology NIRA DYNAMICS AB [Sweden]	Solving the data overload problem in AV and ADAS development MERANTIX AUTOMOTIVE GMBH [German]	Smart Engines for Hybrid Electric Vehicles LIBERTINE FPE LTD. [UK]
12:10 12:50	◆ ◆ ◆	Utilizing Machine Learning in automotive manufacturing OPTIMALPLUS LTD. [Japan]	Noise cancelling technology utilizing Visual info HI AUTO LTD. [Israel]
13:20 14:00	Injection Molded Structural Electronics - Smart Surfaces TACTOTEK OY [Finland]	Rethinking the 3 "Rs" of LIDAR: Rate, Resolution and Range AEYE INC. [USA]	SmartDrive business introduction and case of open innovation SMARTDRIVE INC. [Japan]
14:30 15:10	◆ ◆ ◆	Real range prediction and smart navigation for EVs GPS TUNER SYSTEMS LTD. [Hungary]	To Be Determined VALENS [Israel]
15:30 16:10	AI accelerator market for Automotive & Datacenter market AIMOTIVE K.K. [Japan]	A UNIQUE PLACE TO TEST AND VALIDATE AUTOMATED VEHICLES TRANSPOLIS SAS [France]	To Be Determined PONY AI INC. [China]
16:40 17:20	Leading autonomous mobility and logistics trend in China AUTOX INC. [USA]	Securing the Connected Car from the Cloud UPSTREAM SECURITY LTD. [Israel]	◆ ◆ ◆

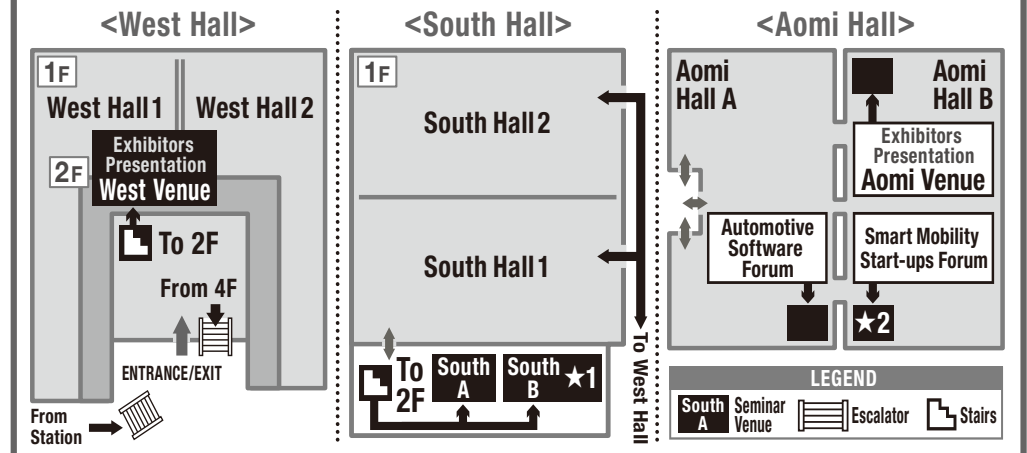
Israel Pavilion's Pitch Event

Venue: South Hall, Presentation Room at 2nd Floor ★1

FREE no pre-registration required

Jan. 16 [Thur] 12:30-17:30 Consecutive presentations by 15 Companies			
Perception is everything ① BRODMANN17 LTD.	Leveraging PCIe for High-Speed In-Car Connectivity ② VALENS	Computer Vision AI Leader for Driver and Cabin Sensing ③ EYESIGHT TECHNOLOGIES LTD.	CipherSIP Introduction ④ CIPHERSIP
Revolutionizing Radar for Safer ADAS and Autonomous Driving ⑤ ARBE	Prevent forgetting kids in cars, while saving OEMs cost ⑥ VAYYAR	Gaining Trust with In-Vehicle Software Management ⑦ AURORA LABS LTD.	Automotive Cyber Threat Landscape ⑧ UPSTREAM SECURITY LTD.
Safe and Secure Remote Operation of Autonomous Vehicles ⑨ DRIVEU LTD.	Changing the World by Re-inventing Human Well-being Sensing ⑩ NETEERA TECHNOLOGIES LTD.	In-Vehicle, End to End Cyber Security Protection ⑪ C2A SECURITY	New Era of Object Detection in All Weather/Light Conditions ⑫ FORESIGHT AUTOMOTIVE LTD.
Trend of DMS and cabin monitoring market and CoDriver demo ⑬ JUNGO CONNECTIVITY LTD.	How Cyber Security Is Transforming The Automotive Market ⑭ ARGUS CYBER SECURITY LTD.	Advanced and Secure High-Performance Automotive Platforms ⑮ GUARDKNOX LTD.	Please refer to the website for the time schedule. The numbers represent the order of presentation.

Seminar Venues inside the Exhibition Halls



See other side for "Keynote Session / Special Session / Technical Session / Maas Forum"